## SQS142ENW

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AUTOMOTIVE

RoHS

COMPLIANT HALOGEN

# Automotive N-Channel 40 V (D-S) 175 °C MOSFET

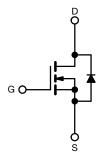


Marking code: Q050

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0045			
I <sub>D</sub> (A)	110			
Configuration	Single			
Package	PowerPAK 1212-8SLW			

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>g</sub> and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25$ °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain current	T <sub>C</sub> = 25 °C	I	110		
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	63		
Continuous source current (diode conduction)		I <sub>S</sub>	103	А	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	271		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	23		
Single pulse avalanche energy	e pulse avalanche energy		26	mJ	
Maximum power dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	D	113	W	
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	37	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperations)	-	260	-0		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount <sup>b</sup>	R <sub>thJA</sub>	81	°C/W		
Junction-to-case (drain)		R <sub>thJC</sub>	1.32	0/10		

#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %
- b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	v	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.3	2.8	3.3	v	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1		
	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	20	-	-	А	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A	-	0.0034	0.0045		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C	-	-	0.0076	Ω	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C	-	-	0.0095	1	
Forward transconductance b	g <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 10 A	-	60	-	S	
Dynamic <sup>b</sup>		•			•			
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	1394	1952	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	474	664		
Reverse transfer capacitance	C <sub>rss</sub>		-	32	45			
Total gate charge <sup>c</sup>	Qg		V <sub>DS</sub> = 20 V, I <sub>D</sub> = 3 A	-	23	35	nC	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	7	-		
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	5	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		1.1	2.2	3.3	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	15	23		
Rise time <sup>c</sup>	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 6.67 \ \Omega \\ I_{D} \cong 3 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$		-	6	9		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	23	35	ns	
Fall time <sup>c</sup>	t <sub>f</sub>			-	7	11		
Source-Drain Diode Ratings and Chara	cteristic <sup>b</sup>						•	
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	271	Α	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V		-	0.82	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	V <sub>DD</sub> = 32 V, I <sub>FM</sub> = 3 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	29	58	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	21	42	nC	
Reverse recovery fall time	ta			-	14	-		
Reverse recovery rise time	t <sub>b</sub>			-	15	-	ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-1.3	-	Α	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

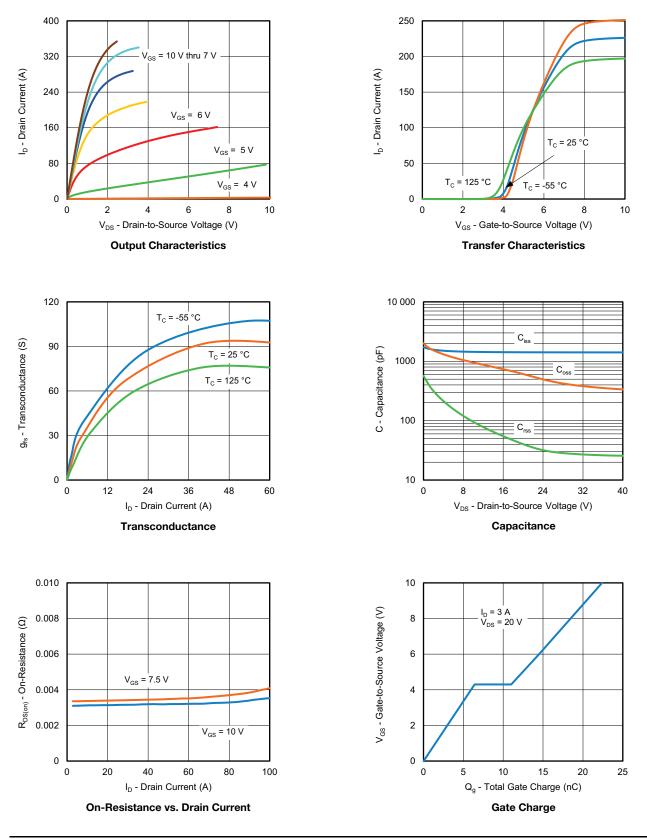
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



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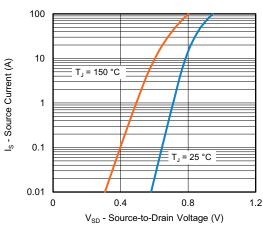
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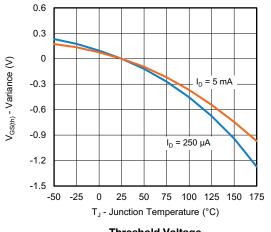
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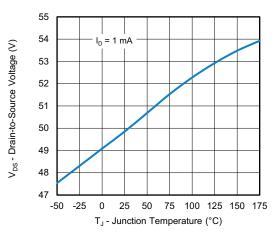
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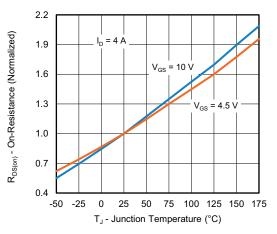
Source Drain Diode Forward Voltage



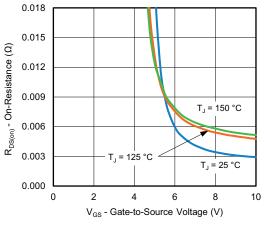




Drain Source Breakdown vs. Junction Temperature



**On-Resistance vs. Junction Temperature** 



**On-Resistance vs. Gate-to-Source Voltage** 

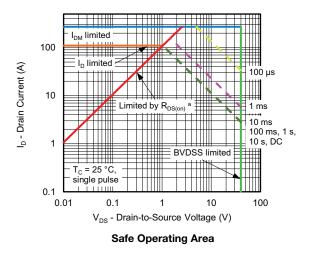
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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



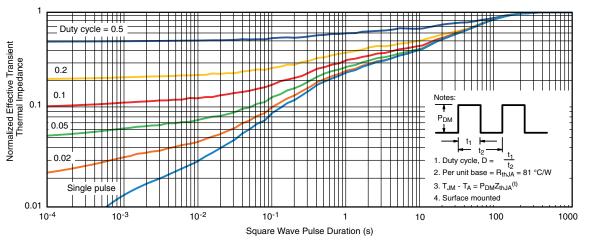
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

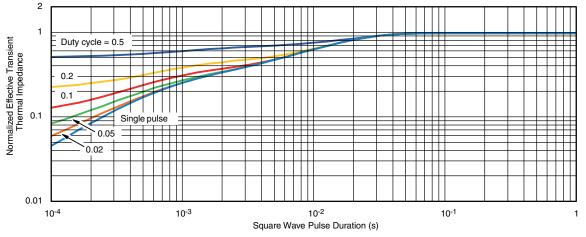


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### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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## RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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